



## GLASS PASSIVATED RECTIFIER

**1N4001G THRU 1N4007G**

**VOLTAGE RANGE  
CURRENT**

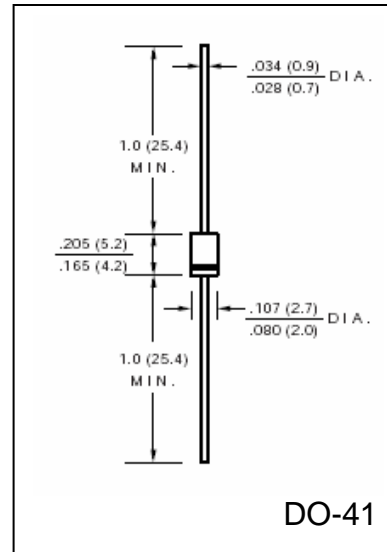
**50 to 1000 Volts  
1.0 Ampere**

### FEATURES

- Glass passivated chip junction
- Low forward voltage
- Low reverse leakage
- High forward surge current capacity
- High temperature soldering guaranteed:  
260 /10 seconds, 0.375" (9.5mm) lead length

### MECHANICAL DATA

- Case: transfer molded plastic
- Epoxy: UL94V – 0 rate flame retardant
- Polarity: Color band denotes cathode end
- Lead: Plated axial lead, solderable per MIL-STD-202E method 208C
- Mounting position: any
- Weight: 0.012 ounce, 0.33 gram



### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

- Ratings at 25°C ambient temperature unless otherwise specified
- Single Phase, half wave, 60Hz, resistive or inductive load
- For capacitive load derate current by 20%

	SYMBOLS	1N 4001G	1N 4002G	1N 4003G	1N 4004G	1N 4005G	1N 4006G	1N 4007G	UNIT
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current, 0.375" (9.5mm) lead length at $T_A = 75^\circ C$	$I_{(AV)}$	1.0							Amps
Peak Forward Surge Current 8.3ms single half sine wave superimposed on rated load (JEDEC method)	$I_{FSM}$	30							Amps
Maximum Instantaneous Forward Voltage @ 1.0A	$V_F$	1.1							Volts
Maximum DC Reverse Current at Rated $T_A = 25^\circ C$	$I_R$	5.0							$\mu A$
DC Blocking Voltage per element $T_A = 125^\circ C$		50							
Maximum Full Load Reverse Current, full cycle Average 0.375" (9.5mm) lead length at $T_L = 75^\circ C$	$I_{R(AV)}$	30							$\mu A$
Typical Junction Capacitance (Measured at 1.0MHz and applied reverse voltage of 4.0V)	$C_J$	15							pF
Typical Thermal Resistance (Note 1)	$R_{\theta JA}$	50							$^\circ C/W$
Operating Junction Temperature Range	$T_J$	(-65 to +175)							$^\circ C$
Storage Temperature Range	$T_{STG}$	(-65 to +175)							$^\circ C$

### Notes:

1. Thermal resistance from junction to ambient with 0.375" (9.5mm) lead length, PCB mounted with 0.2" x 0.2" (5.0mm x 5.0mm) copper pads



# RATINGS AND CHARACTERISTIC CURVES 1N4001G THRU 1N4007G

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

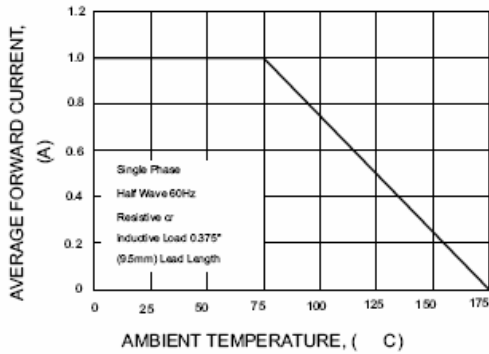


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

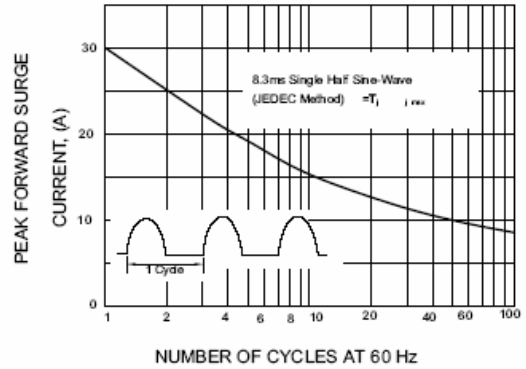


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

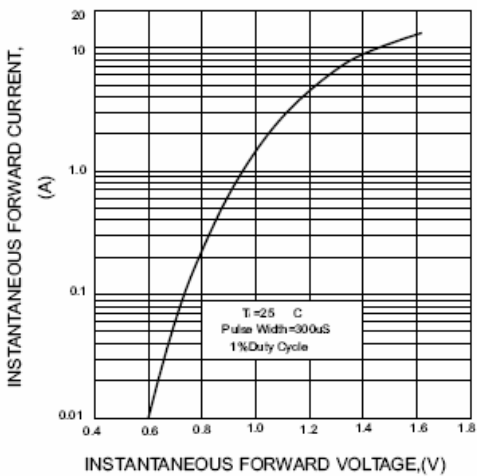


FIG.4-TYPICAL REVERSE CHARACTERISTICS

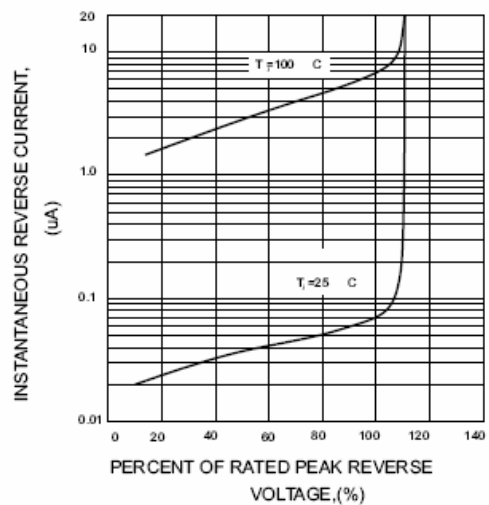


FIG.5-TYPICAL JUNCTION CAPACITANCE

